

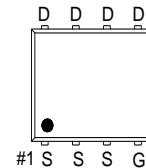
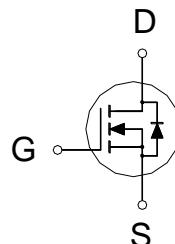
**NIKO-SEM**
**N-Channel Enhancement Mode  
Field Effect Transistor**
**PP9H06BEA**

PDFN 3x3P

Halogen-Free &amp; Lead-Free

**PRODUCT SUMMARY**

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | $I_D$ |
|---------------|--------------|-------|
| 60V           | 9.8mΩ        | 47A   |


 G. GATE  
 D. DRAIN  
 S. SOURCE
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     |                           | SYMBOL         | LIMITS     | UNITS |
|--|---------------------------|----------------|------------|-------|
| Drain-Source Voltage                           |                           | $V_{DS}$       | 60         | V     |
| Gate-Source Voltage                            |                           | $V_{GS}$       | $\pm 20$   | V     |
| Continuous Drain Current                       | $T_C = 25^\circ\text{C}$  | $I_D$          | 47         | A     |
|  | $T_C = 100^\circ\text{C}$ |                | 33         |       |
| Pulsed Drain Current <sup>1</sup>              |                           | $I_{DM}$       | 91         |       |
| Continuous Drain Current                       | $T_A = 25^\circ\text{C}$  | $I_D$          | 17         |       |
|  | $T_A = 70^\circ\text{C}$  |                | 14         |       |
| Avalanche Current                              |                           | $I_{AS}$       | 28         |       |
| Avalanche Energy                               | $L = 0.1\text{mH}$        | $E_{AS}$       | 40         | mJ    |
| Power Dissipation                              | $T_C = 25^\circ\text{C}$  | $P_D$          | 39         | W     |
|  | $T_C = 100^\circ\text{C}$ |                | 20         |       |
| Power Dissipation <sup>3</sup>                 | $T_A = 25^\circ\text{C}$  | $P_D$          | 5          | W     |
|  | $T_A = 70^\circ\text{C}$  |                | 3.5        |       |
| Operating Junction & Storage Temperature Range |                           | $T_j, T_{stg}$ | -55 to 175 | °C    |

**THERMAL RESISTANCE RATINGS**

| THERMAL RESISTANCE               |                     | SYMBOL          | TYPICAL | MAXIMUM | UNITS  |
|----------------------------------|---------------------|-----------------|---------|---------|--------|
| Junction-to-Ambient <sup>2</sup> | $t \leq 10\text{s}$ | $R_{\theta JA}$ |         | 30      | °C / W |
| Junction-to-Ambient <sup>2</sup> | Steady-State        | $R_{\theta JA}$ |         | 50      |        |
| Junction-to-Case                 | Steady-State        | $R_{\theta JC}$ |         | 3.8     |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ\text{C}$ .<sup>3</sup>The Power dissipation is based on  $R_{\theta JA}$   $t \leq 10\text{s}$  value.

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**ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)**

| PARAMETER   | SYMBOL               | TEST CONDITIONS   | LIMITS |      |      | UNIT |
|---|----------------------|---|--------|------|------|------|
|   |                      |   | MIN    | TYP  | MAX  |      |
| <b>STATIC</b>   |                      |   |        |      |      |      |
| Drain-Source Breakdown Voltage  | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA  | 60     |      |      | V    |
| Gate Threshold Voltage  | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                    | 1      | 1.75 | 3    |      |
| Gate-Body Leakage   | I <sub>GSS</sub>     | V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V  |        |      | ±100 | nA   |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>     | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V   |        |      | 1    | μA   |
|   |                      | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 55 °C                           |        |      | 10   |      |
| Drain-Source On-State Resistance <sup>1</sup>                                 | R <sub>DS(ON)</sub>  | V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A   |        | 8.1  | 9.8  | mΩ   |
|   |                      | V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 20A  |        | 12   | 16   |      |
| Forward Transconductance <sup>1</sup>   | g <sub>fs</sub>      | V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A  |        | 43   |      | S    |
| <b>DYNAMIC</b>  |                      |   |        |      |      |      |
| Input Capacitance   | C <sub>iss</sub>     | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 30V, f = 1MHz   |        | 1111 |      | pF   |
| Output Capacitance  | C <sub>oss</sub>     |   |        | 574  |      |      |
| Reverse Transfer Capacitance  | C <sub>rss</sub>     |   |        | 27   |      |      |
| Gate Resistance   | R <sub>g</sub>       | V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz  |        | 1.2  |      | Ω    |
| Total Gate Charge <sup>2</sup>  | Q <sub>g</sub>       | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 10V,<br>I <sub>D</sub> = 20A                         |        | 18   |      | nC   |
|   |                      |   |        | 9.8  |      |      |
| Gate-Source Charge <sup>2</sup>   | Q <sub>gs</sub>      |   |        | 3.3  |      |      |
| Gate-Drain Charge <sup>2</sup>  | Q <sub>gd</sub>      |   |        | 4.3  |      |      |
| Turn-On Delay Time <sup>2</sup>   | t <sub>d(on)</sub>   | V <sub>DS</sub> = 30V ,<br>I <sub>D</sub> ≈ 20A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω |        | 11   |      | nS   |
| Rise Time <sup>2</sup>  | t <sub>r</sub>       |   |        | 55   |      |      |
| Turn-Off Delay Time <sup>2</sup>  | t <sub>d(off)</sub>  |   |        | 26   |      |      |
| Fall Time <sup>2</sup>  | t <sub>f</sub>       |   |        | 100  |      |      |
| <b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b> |                      |   |        |      |      |      |
| Continuous Current  | I <sub>S</sub>       | I <sub>F</sub> = 20A, V <sub>GS</sub> = 0V  |        |      | 33   | A    |
| Forward Voltage <sup>1</sup>  | V <sub>SD</sub>      |   |        |      | 1.2  | V    |
| Reverse Recovery Time   | t <sub>rr</sub>      |   |        |      | 25   | nS   |
| Reverse Recovery Charge   | Q <sub>rr</sub>      |   |        |      | 12   | nC   |

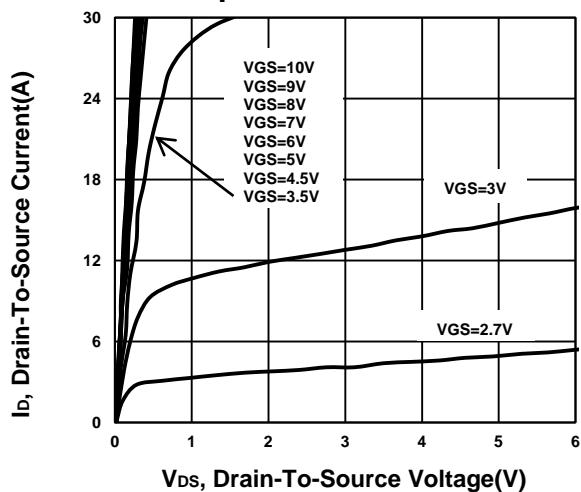
<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.<sup>2</sup>Independent of operating temperature.

**NIKO-SEM**

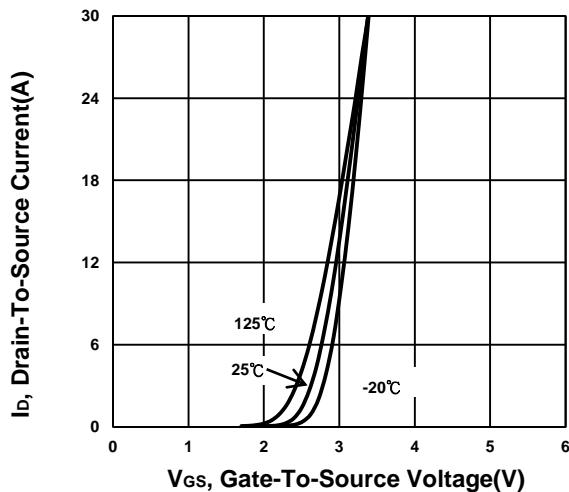
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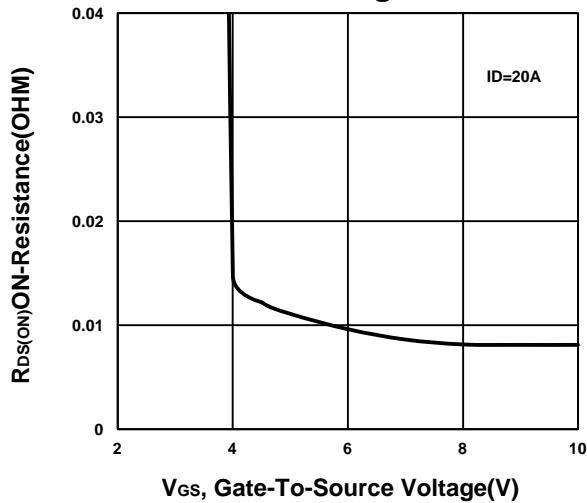
### Output Characteristics



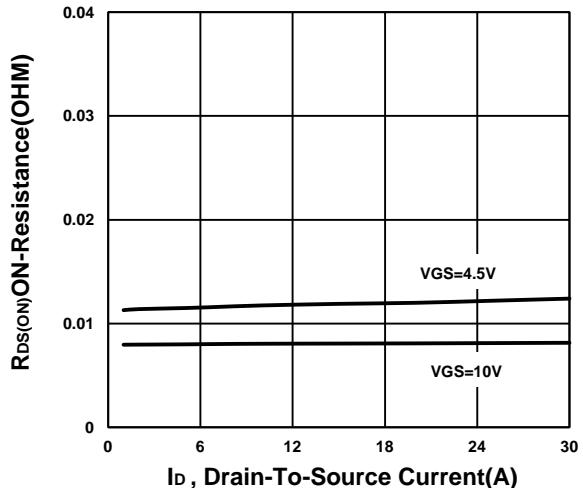
### Transfer Characteristics



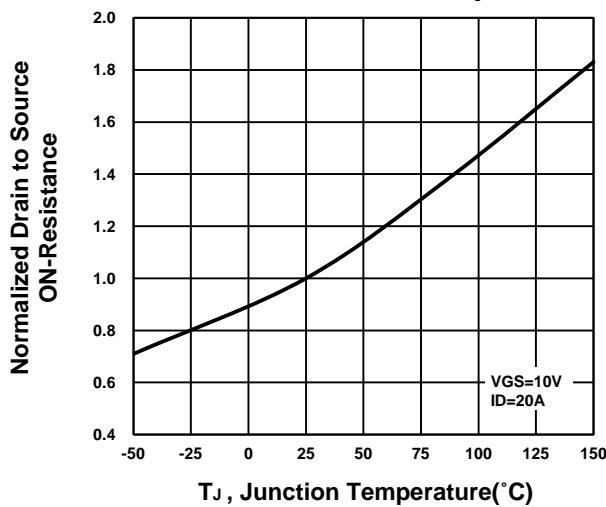
### On-Resistance VS Gate-To-Source Voltage



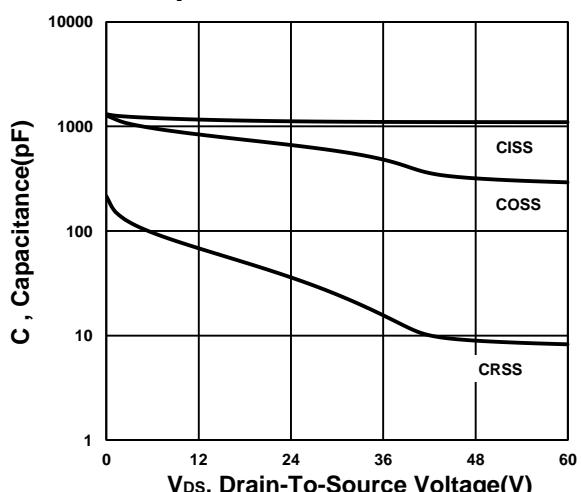
### On-Resistance VS Drain Current



### On-Resistance VS Temperature



### Capacitance Characteristic

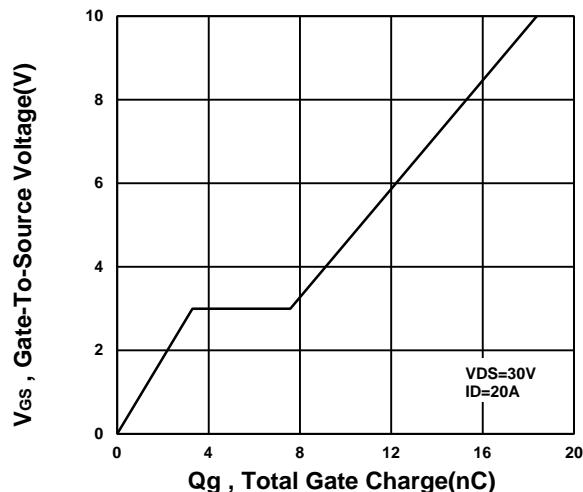


**NIKO-SEM**

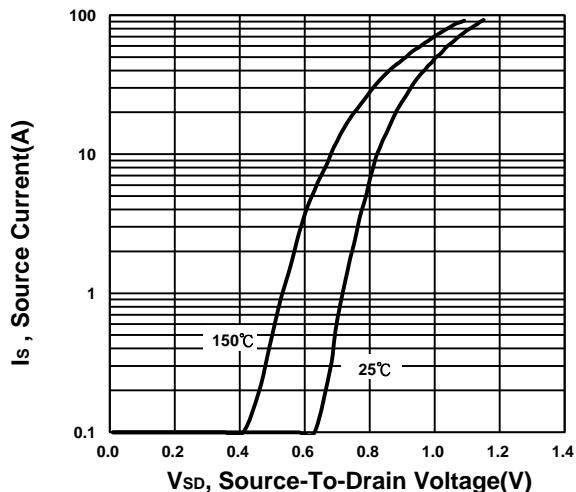
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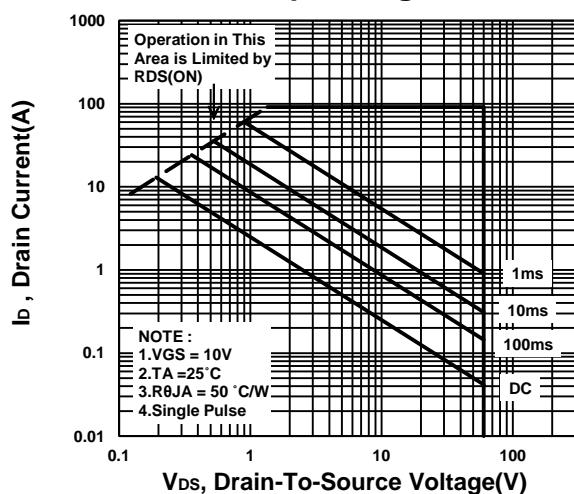
**Gate charge Characteristics**



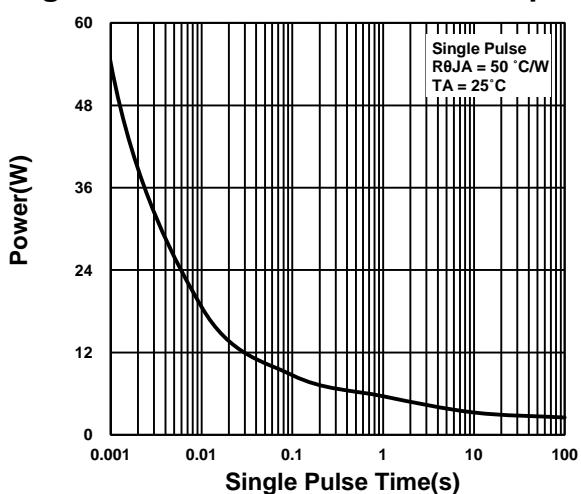
**Source-Drain Diode Forward Voltage**



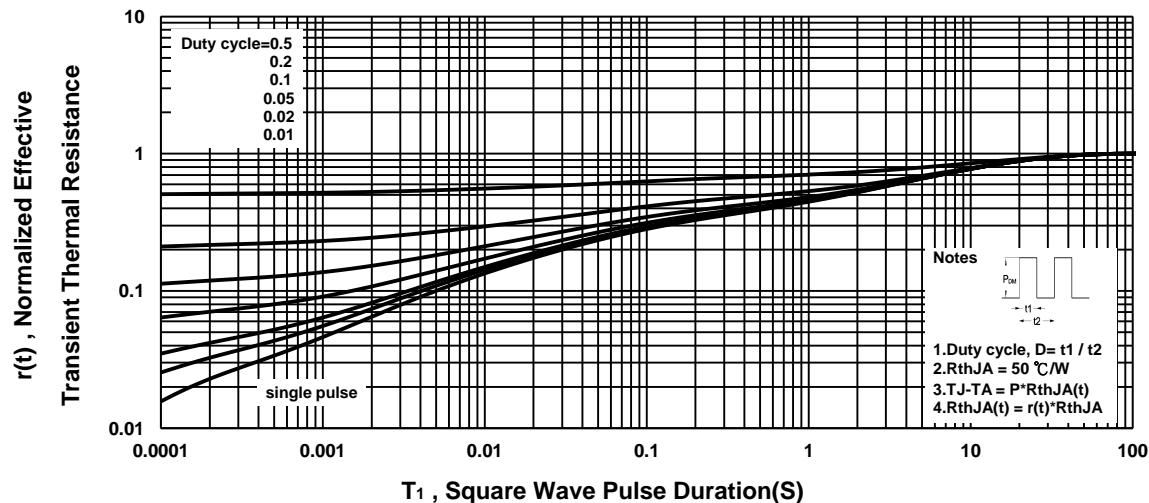
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



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